

CLAIMS

WHAT IS CLAIMED IS:

1. A thermal device for applying thermal energy to the body of a person, animal or
2 other surface, comprising:
degermed corn; and
4 an enclosure configured to enclose said degermed corn.
2. The thermal device of Claim 1, wherein said enclosure is made from fabric.
3. The thermal device of Claim 1, wherein said degermed corn is kiln dried.
4. The thermal device of Claim 1, wherein said degermed corn is oven dried.
5. The thermal device of Claim 1, wherein said enclosure is generally rectangular.
6. A thermal device for applying thermal energy to the body of a person, animal or
2 other surface, comprising segmented grain configured to accept thermal energy.
7. A method of applying thermal energy to the body of a person, animal or other
2 surface, comprising:
providing a thermal device including segmented grain;
4 subjecting said thermal device to thermal energy; and

applying said thermal device to a surface to be treated.

8. The thermal device of Claim 7, wherein said segmented grain is corn.

9. The thermal device of Claim 7, wherein said segmented grain is degermed corn.

10. The thermal device of Claim 7, wherein said segmented grain is embryo-free
2 corn.

11. The thermal device of Claim 10, wherein said degermed corn dissipates thermal
2 energy relatively slowly.

12. A thermal device for applying thermal energy to the body of a person, animal or
2 other surface, comprising:

segmented organic filler; and

4 a receptacle configured to enclose said segmented organic filler.

13. The thermal aid of Claim 12, wherein said segmented organic filler is degermed
2 grain.

14. The thermal aid of Claim 12, wherein said segmented organic filler is embryo-
2 free grain.

15. The thermal aid of Claim 12, wherein said segmented organic filler is kiln-dried grain.

16. The thermal device of Claim 12, wherein said segmented organic filler is oven dried.

17. The thermal aid of Claim 12, wherein said segmented organic filler is dissected grain.

18. The thermal aid of Claim 12, wherein said segmented organic filler is corn.

19. The thermal device of Claim 12, wherein receptacle is generally rectangular.

20. A method of making a thermal device, comprising:

providing grain;

segmenting said grain;

enclosing said segmented grain in an enclosure.

21. The method of Claim 20, wherein said segmenting comprises:

cleaning the grain to remove foreign material;

tempering the grain;

removing the embryo;

sifting out undesirable elements to produce a resulting grain; and
6 drying said resulting grain.